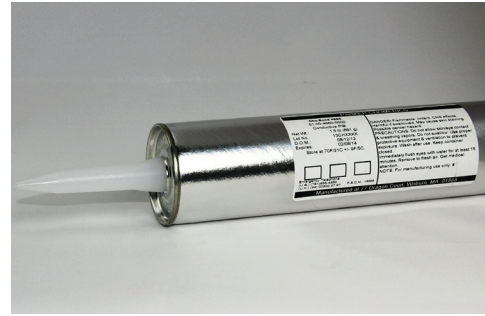


CHO-BOND® 4660 and 4669

ONE COMPONENT FLEXIBLE ELECTRICALLY CONDUCTIVE POLYISOBUTYLENE SEALANT



Customer Value Proposition:

CHO-BOND 4660 is a silver-plated copper filled, one-component conductive polyisobutylene. It is designed for use as a fillet, gap filler and seam sealant on electrical enclosures for EMI shielding or electrical grounding. Its non-hardening characteristic makes it particularly suited for shielding joints and seams which are likely to be disassembled or applications where vibration and thermal shock resilience is required. Minimum recommended bond line for CHO-BOND 4660 is 0.015 inches (0.18 mm). CHO-BOND 4660 dries to touch in minutes and develops its final material properties in 168 hours. The compound remains permanently flexible and adherent with no tendency to crack or pull away from the substrate. Some surface crusting may be experienced, but CHO-BOND 4660 will remain pliable below the surface. In addition, CHO-BOND 4660 may be used to help seal against gases as the polyisobutylene polymer system has excellent impermeability properties.

Parker Chomerics also offers an extended working life version of CHO-BOND 4660 called CHO-BOND 4669. CHO-BOND 4669 will exhibit the same final properties as CHO-BOND 4660 but has an extended, 2 hour working life. Typical applications include access panels, shielded room joints, temporary military shelters, hardware, bulkhead feed through fittings, and building conduits.

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Authorized Distributor



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www.krafab.com
408-825-1900



Features and Benefits:

- One component
- Easy to use, no weighing or mixing required.
- Silver plated copper filler
- Good conductivity 0.080 ohm-cm
- Polyisobutylene binder
- 30 minute working life, 168 hrs for final properties to develop, remains flexible, No corrosive by-products generated during drying to damage substrate, excellent impermeability to gases. Primerless system.
- Light weight
- More coverage per gram of material, minimal weight added to assembly or vehicle.
- Gritty paste
- Easy to dispense with standard caulking gun. CHO-BOND 4660 can be used on overhead or vertical surfaces.
- Extended working life version: CHO-BOND 4669
- 2 hr working life, 168 hrs for final properties to develop, slower evaporating solvent system.

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CHO-BOND 4660 and 4669 Conductive Caulk - Product Information

Table 1 Typical Properties

| Typical Properties | Typical Values | | Test Method |
|--|--|---------------|-----------------------|
| | CHO-BOND 4660 | CHO-BOND 4669 | |
| Polymer | Polyisobutylene | | N/A |
| Filler | Silver-Plated Copper | | N/A |
| Mix Ratio, A : B (by weight) | 1-part | | N/A |
| Color | Black | Gray | N/A (Q) |
| Consistency | Gritty Paste | | N/A (Q) |
| Maximum DC Volume Resistivity | 0.080 ohm-cm | | CHO-95-40-5555* (Q/C) |
| Minimum Lap Shear Strength | N/A | | CHO-95-40-5300* |
| Minimum Peel Strength | N/A | | CHO-95-40-5302* |
| Wet Density | 2.0 g/ml | | ASTM D792 (Q/C) |
| Hardness | N/A | | ASTM-D2240 |
| Continuous Use Temperature | - 55°C to 100°C (-67 °F to 212 °F) | | N/A (Q) |
| Elevated Temperature Cure Cycle | None | | N/A |
| Room Temperature Cure | 1 week** | | N/A (Q) |
| Working Life | 0.5 hour | 2.0 hours | N/A (Q) |
| Shelf Life, unopened | 6 months @ 25°C (77°F) | | N/A (Q) |
| Minimum thickness recommended | 0.015 in (0.18 mm) | | N/A |
| Maximum thickness recommended | 0.125 in (3.18 mm) | | N/A |
| Volatile Organic Content (VOC) | 305 g/l | 340 g/l | Calculated |
| Theoretical Coverage Area at 0.010" Thick per Pound (454 grams) | 1375 in ² (8871 cm ²) | | N/A |
| Theoretical Coverage - Length of an 1/8" Diameter Bead per Pound (454 grams) | 90 feet (27.4 m) | | N/A |

Note: N/A - Not Applicable, (Q/C) - Qualification and Conformance Test, (Q) - Qualification Test

* This test Method is available from Parker Chomerics.

** Cure is sufficient for handling in 24 hours. Full specification properties are developed after 1 week (168 hours).

Table 2 Ordering Information

| Product | Weight (grams) | Packaging | Part Number | Primer Included |
|---------------|----------------|----------------------------------|-----------------|-----------------|
| CHO-BOND 4660 | 113.4 | 2 fluid ounce aluminum foil tube | 51-02-4660-0000 | Not Required |
| | 681 | 0.1 gallon fiber cartridge | 51-05-4660-0000 | Not Required |
| CHO-BOND 4669 | 113.4 | 2 fluid ounce aluminum foil tube | 51-02-4669-0000 | Not Required |
| | 681 | 0.1 gallon fiber cartridge | 51-05-4669-0000 | Not Required |

Please refer to Parker Chomerics Surface Preparation and CHO-BOND Application documents for information regarding the proper surface preparation, primer application (if required), and use of these compounds.

www.chomerics.com
www.parker.com/chomerics

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